

DATASHEET

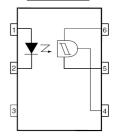
6 PIN DIP SCHMITT TRIGGER PHOTOCOUPLER H11LX Series



Features:

- · High data rate, 1MHz typical (NRZ)
- Free from latch up and oscillation throughout voltage and temperature ranges.
- Microprocessor compatible drive
- Logic compatible output sinks 16mA at 0.4V maximum
- · Guaranteed on/off threshold hysteresis
- Wide supply voltage capability, compatible with all popular logic systems
- High isolation voltage between input and output (Viso=5000 V rms)
- · Compact dual-in-line package
- Pb free and RoHS compliant.
- UL approved (No. E214129)
- VDE approved (No. 132249)
- SEMKO approved
- NEMKO approved
- DEMKO approved
- FIMKO approved
- CSA approved

Schematic



Pin Configuration

- 1. Anode
- 2. Cathode
- 3. No Connection
- 4. V_O
- 5. GND
- $6. V_{CC}$

Truth Table

Input	Output
Н	L
L	Н

Description

The H11LX series of devices each consist of a GaAs infrared emitting diode optically coupled a high speed integrated circuit detector. The output detector incorporates a Schmitt trigger, which provides hysteresis for noise immunity and pulse shaping.

The devices are in a 6-pin DIP package and available in wide-lead spacing and SMD option.

Applications

- Logic to logic isolator
- Programmable current level sensor
- Line receiver eliminate noise and transient problems
- AC to TTL conversion square wave shaping
- Digital programming of power supplies
- Interfaces computers with peripherals



Absolute Maximum Ratings (Ta=25℃)

	Parameter	Symbol	Rating	Unit
Input	Forward current	I _F	60	mA
	Reverse voltage	V_{R}	6	V
	Power dissipation	P_{D}	120	mW
Output	V ₄₅ Allowed Range	Vo	0 to 16	V
	V ₆₅ Allowed Range	V _{CC}	3 to 16	V
	Output Current	I ₀	50	mA
	power dissipation	P_{D}	150	mW
Total powe	r dissipation	P _{tot}	250	mW
Isolation vo	oltage	V _{iso}	5000	V rms
Operating	temperature	T_{opr}	-55~+100	∞
Storage te	mperature	T _{stg}	-55~+150	∞
Soldering t	temperature *2	T _{sol}	260	∞

Notes:

^{*1} AC for 1 minute, R.H.= $40 \sim 60\%$ R.H. In this test, pins 1, 2 & 3 are shorted together, and pins 4, 5 & 6 are shorted together.

^{*2} For 10 seconds



Electro-Optical Characteristics (Ta=25℃ unless specified otherwise)

Input

Parameter	Symbol	Min.	Тур.*	Max.	Unit	Condition
Forward Voltage	V_{F}	-	1.15	1.5	٧	I _F = 10mA
Reverse Current	I _R	-	-	10	μΑ	V _R = 5V
Input capacitance	CJ	-	-	100	pF	V=0, f=1MHz

Output

Parameter	Symbol	Min.	Тур.*	Max.	Unit	Condition
Operation Voltage Range	V_{CC}	3	-	15	V	
Supply Current	$I_{CC(off)}$	-	1.6	5	mA	I _F =0mA, Vcc=5V
Output Current, High	I _{OH}	-	-	100	μΑ	I _F =0mA, Vcc=Vo=15V
Isolation Resistance	R _{ISO}	10 ¹¹	-	-	Ω	V _{I-O} =500VDC

Transfer Characteristics

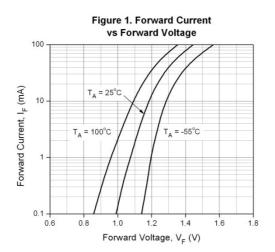
Pa	rameter	Symbol	Min	Тур.	Max.	Unit	Condition
Supply Curre	ent	$I_{CC(on)}$	-	1.6	5	mA	I _F =10mA, Vcc=5V
Output Voltage .low		V_{OL}	-	-	0.4	V	Vcc=5V, $I_F=I_{Fon}(max.)$, $R_L=270 \Omega$
Turn on	H11L1		-	-	1.6		
Threshold Current ¹	H11L2	I _{Fon}	-	-	10	mA	Vcc=5V, R _L =270 Ω
Current	H11L3	_	-	-	5	_	
Turn off Thre	shold Current	I_{Foff}	-	1	-	mA	Vcc=5V, R _L =270 Ω
Hysteresis Ratio		I _{Foff} /I _{Fon}	0.5	-	0.9		Vcc=5V, R _L =270 Ω
Turn on Time	9	t _{on}	-	-	4	μ S	
Fall Time		t _r	-	0.1	-	μ S	Vcc=5V,
Turn off Time	9	t _{off}	-	-	4	μS	- $I_{F=I_{Fon}}$, R_{L} =270 Ω
Rise Time		t _r	-	0.1	-	μS	-
Data Rate			-	1	-	MHz	

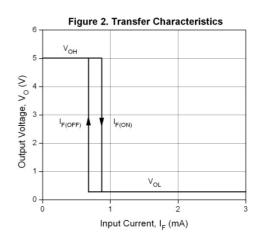
^{*} Typical values at T_a = 25 °C

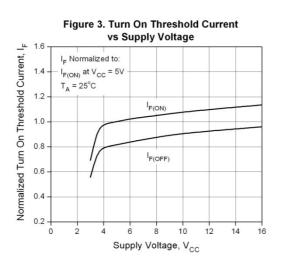
¹. Max. I_{F(ON)} is the maximum current required to trigger the output. For examples, a 1.6mA maximum trigger current would require the LED to be driven at a current greater than 1.6mA to guarantee the device will turn on. A 10% guard band is recommended to account for degradation of the LED over its lifetime. The maximum allowable LED drive current is 60mA.

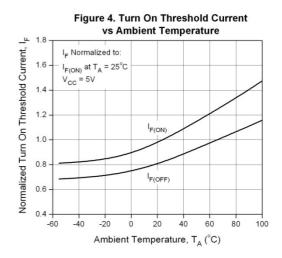


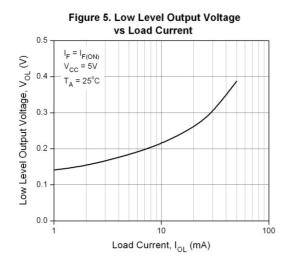
Typical Electro-Optical Characteristics Curves

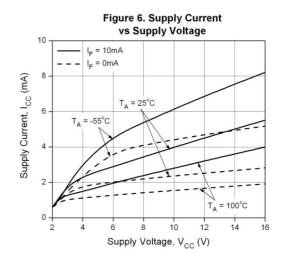












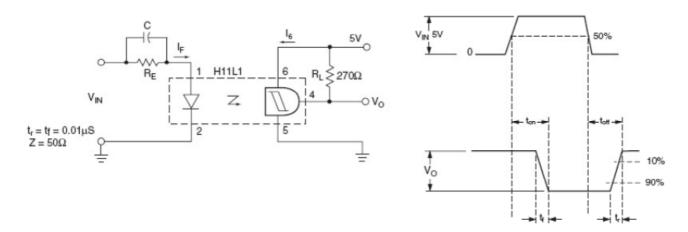


Figure 7. Switching Time Test Circuit & Waveforms

Order Information

Part Number

H11LXY(Z)-V

Note

X = Part No. for 1, 2 or 3

= Lead form option (S, S1, M or none)

= Tape and reel option (TA, TB or none).

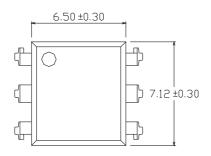
= VDE (optional)

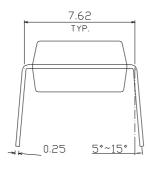
Option	Description	Packing quantity
None	Standard DIP-6	65 units per tube
М	Wide lead bend (0.4 inch spacing)	65 units per tube
S + TA	Surface mount lead form + TA tape & reel option	1000 units per reel
S + TB	Surface mount lead form + TB tape & reel option	1000 units per reel
S1 + TA	Surface mount lead form (low profile) + TA tape & reel option	1000 units per reel
S1 + TB	Surface mount lead form (low profile) + TB tape & reel option	1000 units per reel

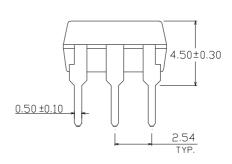


Package Dimension (Dimensions in mm)

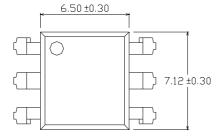
Standard DIP Type

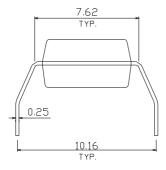


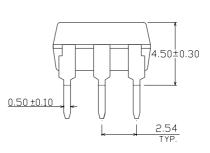




Option M Type

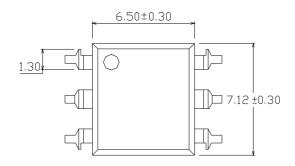


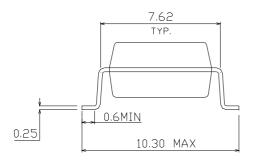


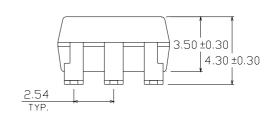




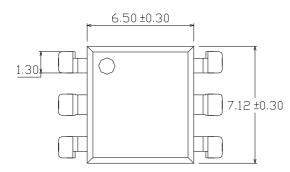
Option S Type

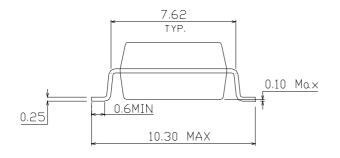


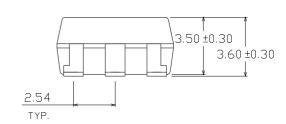




Option S1 Type

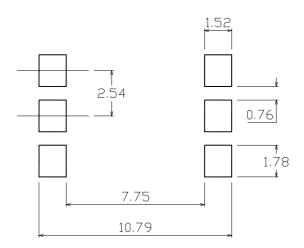




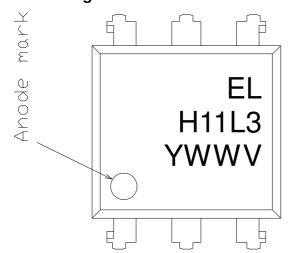




Recommended pad layout for surface mount leadform



Device Marking



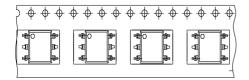
Notes

EL denotes Everlight
H11L3 denotes Device Number
Y denotes 1 digit Year code
WW denotes 2 digit Week code
V denotes VDE (optional)



Tape & Reel Packing Specifications

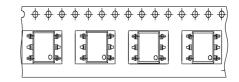
Option TA



Direction of feed from reel



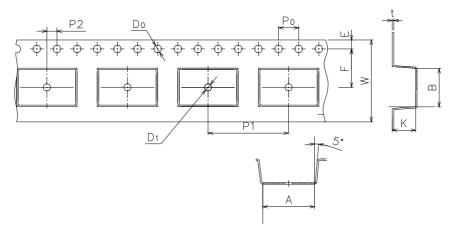
Option TB



Direction of feed from reel



Tape dimensions



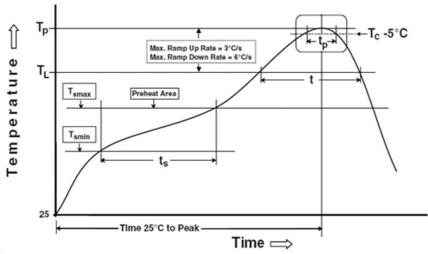
Dimension No.	Α	В	Do	D1	E	F
Dimension(mm)	10.4±0.1	7.5±0.1	1.5±0.1	1.5+0.1/-0	1.75±0.1	7.5±0.1
Dimension No.	Ро	P1	P2	t	W	К
Dimension(mm)	4.0±0.15	12±0.1	2.0±0.1	0.35±0.03	16.0±0.2	4.5±0.1



Precautions for Use

1. Soldering Condition

1.1 (A) Maximum Body Case Temperature Profile for evaluation of Reflow Profile



Note:

Reference: IPC/JEDEC J-STD-020D

3 times

Preheat

Temperature min (T _{smin})	150 ℃
Temperature max (T _{smax})	200℃
Time $(T_{smin} \text{ to } T_{smax}) (t_s)$	60-120 s

Time $(T_{smin} \text{ to } T_{smax})$ (t_s) 60-120 seconds Average ramp-up rate $(T_{smax} \text{ to } T_p)$ 3 °C/second max

Other

Liquidus Temperature (T _L)	217 ℃
Time above Liquidus Temperature (t L)	60-100 sec
Peak Temperature (T _P)	260℃
Time within 5 $^{\circ}\!\text{C}$ of Actual Peak Temperature: T_P - $5^{\circ}\!\text{C}$	30 s
Ramp- Down Rate from Peak Temperature	6°C /second max.
Time 25 ℃ to peak temperature	8 minutes max.

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Reflow times



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